The Shape that Fits the Future

DC3217IYE

Introducing Intel's Next Unit of Computing Kit DC3217IYE

PRODUCT BRIEF

THINK YOU KNOW WHAT SMALL CAN DO? THINK AGAIN.

SUPERIOR PROCESSING AND GRAPHICS

STUNNINGLY SMALL FORM FACTOR

ADVANCED TECHNOLOGY

Full PC functionality in its simplest form

,QWHOŠ *LJDELW (WKHUQHW

Dual HDMI ports supporting
dual independant display capability

'XDO 86% 3RUWV

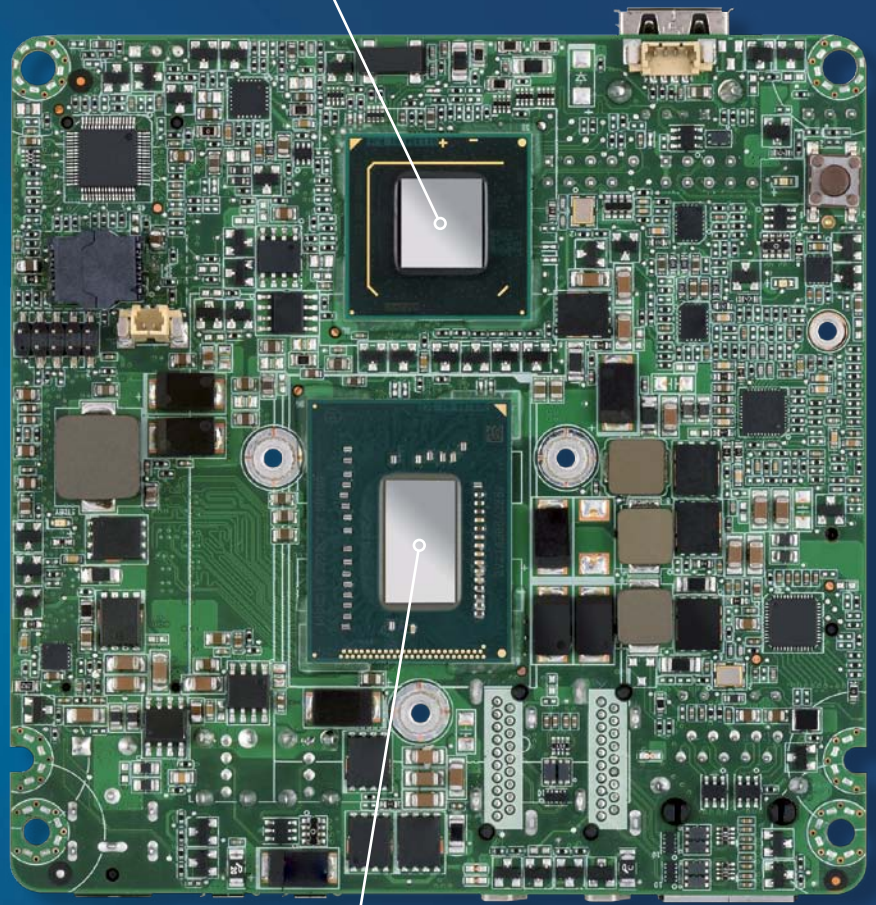
9 : '&
Power connector

Dual Mini PCIe slots
for expandability

)URQW 3DQHO 86%

'XDO 62 ',00 VRFNHWV
IRU PHPRU\ H[SDQGDELOLW\ XSWR *%

Intel® QS77 Express chipset



µ FP

3RUW

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Intel® Core™ i3-3217U processor

ZLWK ,QWHOŠ 'HVNWRS

Intel WiDi Wireless Display

Intel ANTI-THEFT TECHNOLOGY

Windows 8 Compatible

Intel® Next Unit of Computing Kit DC3217IYE

7HFKQLFDO 6SHFLÀFDWLRQV

PROCESSOR
Processor Support

‡,QWHOŠ &RUHŒ L 8 3URFHVVRU

*+] 'XDO &RUH SURFHVVRU ZLWK

‡6XSSRUWV ,QWHOŠ DUFKLWHFWXUH

CHIPSET
‡,QWHOŠ 46 ([SUHVV &KLSVHW

GRAPHICS
‡,QWHOŠ +' *UDSKLFV

‡'XDO +'0, 3RUWV VXSSRUWLQJ GXDO LQGHSHQGHQW GLVSOD\ capability

PERIPHERAL CONNECTIVITY
‡,QWHJUDWHG ,QWHO 1HWZRUN &RQQHFWLRQ

‡7KUHH +L 6SHHG 86% SRUWV WZR EDFN SDQHO SRUWV DQG one front panel port)

EXPANSION CAPABILITIES[2]
‡2QH IXOO OHQJWK PLQL 3&,H VORW capability

‡2QH KDOI OHQJWK PLQL 3&,H VORW ZLWK GXDO 86% SRUWV routed

SYSTEM BIOS
‡,QWHOŠ 9LVXDO %LRV

0E)ODVK ((3520 ZLWK ,QWHOŠ 3ODWIRUP ,QQRYDWLRQ

)UDPHZRUN IRU (;,

60%,26

‡,QWHOŠ ([SUHVV %,26 XSGDWH VXSSRUW

Fast Boot BIOS – Optimized POST for almost instant-on access to PC from power on

SYSTEM MEMORY[1]
Memory Capacity

‡'XDO FKDQQHO ''5 ZLWK WZR FRQQHFWRUV IRU 0+] PHPRU\ VXSSRUW *% PD[

Memory Voltage

HARDWARE MANAGEMENT FEATURES
‡3URFHVVRU IDQ VSHHG FRQWURO

‡9ROWDJH DQG WHPSHUDWXUH VHQVLQJ

‡$&3, FRPSOLDQW SRZHU PDQDJHPHQW FRQWURO

INTEL® PRO 10/100/1000 NETWORK CONNECTION
‡/RZ SRZHU GHVLJQ

AUDIO
‡,QWHOŠ +LJK 'HÀQLWLRQ $XGLR

‡'LJLWDO DXGLR VXSSRUWLQJ audio

INDICATORS AND CONTROLS
$3RZHU /('

‡ 3RZHU RQ RII

MECHANICAL
Chassis Size

‡ PP PP PP

Board Size

Baseboard Power Requirements

‡'& 3RZHU 9 :DWW

ENVIRONMENT
Operating Temperature

Storage Temperature

COMPLIANCE WITH REGULATIONS AND STANDARDS
Safety Regulations

F8/ &6$

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120 6&),

*267 5

EMC Class B Regulations

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)&& &)5 3DUW 6XESDUW %

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,(& (1 6HULHV

VCCI V-3

KN-22

KN-24

&16

ENVIRONMENTAL COMPLIANCE
(XURSH 5R+6

&KLQD 5R+6

:$51,1* $OWHULQJ 3& PHPRU\ IUHTXHQF\ YROWDJH system stability and useful life of the system, memory and processor; (ii) cause the processor and other system components to fail; (iii) cause reductions in system performance; (iv) cause additional heat or other damage; and (v) affect system data memory being available to the operating system and applications, depending on

Intel products are not intended for use in medical, life-saving, or life-sustaining

All products, dates, and figures specified are preliminary based on current

2nd gen Intel® Core™ processor-based PCs with built-in visuals enabled,